

Specification Sheet

Model No. : ZJY154

Description : 3.5inch TFT LCD Screen resolution
320*480 TFT LCD With Touch Panel
Size:55.26*84.52*3.45mm Driver Chip ILI9486L interface
8/16bits parallel 37Pin Voltage V Font Color Option Full Color
ZJY154

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1. General Description

ZJY154 is a 320RGB*480 dots matrix TFT LCD module. It has a TFT panel composed of 960 sources and 480gates. The LCM can be easily accessed by micro-controller.

2. Features

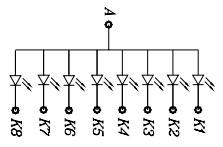
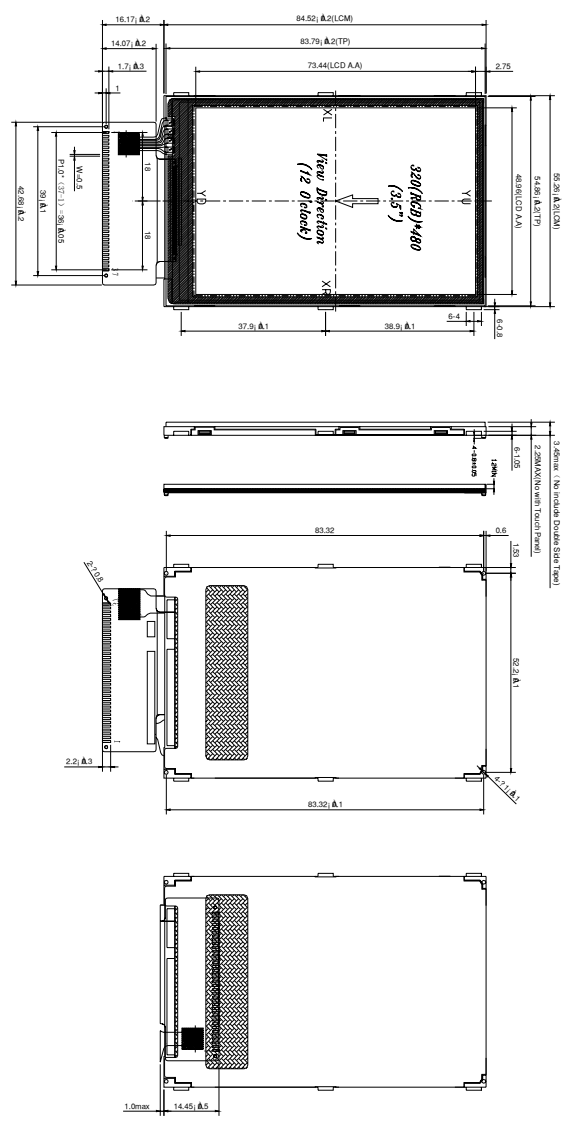
Display Mode	Transmissive
	a-TFT
Display Format	Graphic 320RGB*480 Dot-matrix
Input Data	8 /16bits parallel interface
Viewing Direction	12 o'clock
Drive	ILI9486L

3. Mechanical Specification

Item	Specifications	Unit
Dimensional outline	55.26(W)*84.52 (H)*3.45MAX(T) (FPC not include)	mm
Resolution	320RGB*480	dots
LCD Active area	48.96(W)*73.44(H)	mm
Pixel size	0.153(W)*0.153(H)	mm

4. Mechanical Dimension

PIN	SYMBOL
1	GND
2	VCC
3	IOVCC
4	CS
5	RS
6	WR
7	R/D
8	RESET
9	DB0
10	DB1
11	DB2
12	DB3
13	DB4
14	DB5
15	DB6
16	DB7
17	DB8
18	DB9
19	DB10
20	DB11
21	DB12
22	DB13
23	DB14
24	DB15
25	GND
26	V0
27	XR
28	Y0
29	XL
30	LEDK
31	LEDK
32	LEDK
33	LEDK
34	LEDK
35	LEDA
36	LEDA
37	GND



- NOTES:
1. DISPLAY TYPE: TFT
 2. OPERATING TEMP: -20° C ~ 70° C
 3. STORAGE TEMP: -30° C ~ 80° C
 4. LCD DRIVER: COG (IC: ILI9486L);
 5. BACKLIGHT: 8 CHIP-WHITE LED
 6. GENERAL TOLERANCE: ±0.20
 7. ROHS

REV	DESCRIPTION	DATE	APPROVED BY:	SCALE:	SHEET NO.:	OF
G-1	ISSUE	14.5.20	Zouquan 2015/14	1:1	1	OF

DRAWN BY:		TITLE:		UNIT:	
LUDIAN 2015/14	ZJY154	mm			
MEASURED BY:		DWG NO.:		V.O.3	
Zouquan 2015/14					
EE CHECKED BY:		SCALE:		SHEET NO.:	
Zouquan 2015/14		1:1	1 OF		

ICBANQ Inc.

5. Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
Supply voltage	V	-0.3	4.6	V	
Operating temperature	V _T	-0.3	V _{CC} +0.3	V	
Storage temperature	T _{OPR}	-20	70	°C	
Storage temperature	T _{STR}	-30	80	°C	

6. Electrical Characteristics

Item		Symbol	Condition	Min.	Typ.	Max.	Unit
Supply voltage	Logic	V _{CC}		2.7	2.8	3.3	V
Input Voltage	H level	T _{IH}		0.8*IOVCC		IOVCC	V
	L level	T _{IL}		-0.3		0.2* IOVCC	
Storage temperature		I _{DD}	With internal voltage generation V _{CC} =2.8V; T _{emp} =25°C			TBD	mA

7. Backlight Characteristic

Item	Symbol	Min	Typical	Max	Unit
LED module Forward voltage	V _{LED}	3.0	3.2	3.4	V
LED module current	V _{LED}		120		mA
L/G Surface Luminance ★1	L _S	4000			Cd/m ³
LCM Surface brightness uniform ★2	L _D	80			%

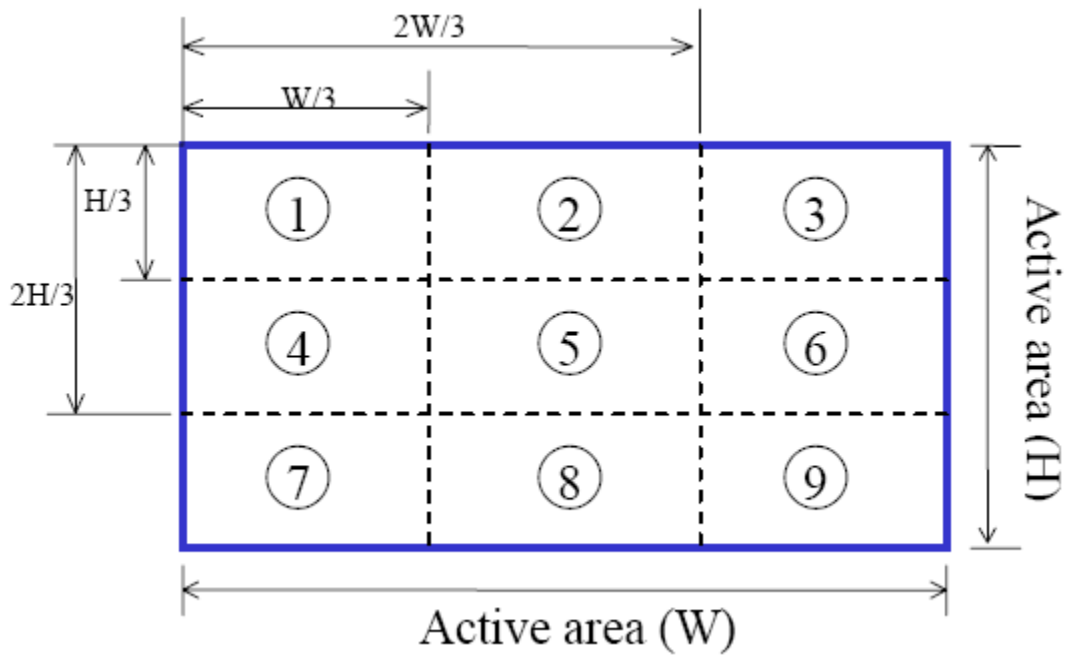
★ 1Test condition is:

- (a) Center point on active area.
- (b)Best Contrast.

★2Uniform measure condition:

- (1)Measure 9 point. Measure location show below;
- (2)Uniform=(Min. brightness /Max. brightness)*100%

(3)Best Contrast.



8. Module Function Description

8.1 Pin Descriptions

PIN No.	Symbol	Description
1	GND	Ground
2	VCC	Power supply for LCM (2.8V-3.3V)
3	IOVCC	Power supply for LCM (2.8V-3.3V)
4	CS	Chip select pin ("Low" enable)
5	RS	This pin is used to select "Data or Command" in the parallel interfacel When RS= '1', data is selected. When RS= '0', command is selected. If not used, this pin should be connected to IOVCC or GND.
6	WR	- 8080 system (WRX): Serves as a write signal and writes data at the rising edge. Fix to IOVCC or GND level when not in use.
7	RD	Serves as a read signal and MCU read data at the rising edge. Fix to IOVCC or GND level when not in use.
8	RESET	LCM Reset pin Signal is active low.
9-16	DB0-DB7	Data bus Fix to GND level when not in use
17-24	DB8-DB15	Data bus Fix to GND level when not in use
25	GND	Ground

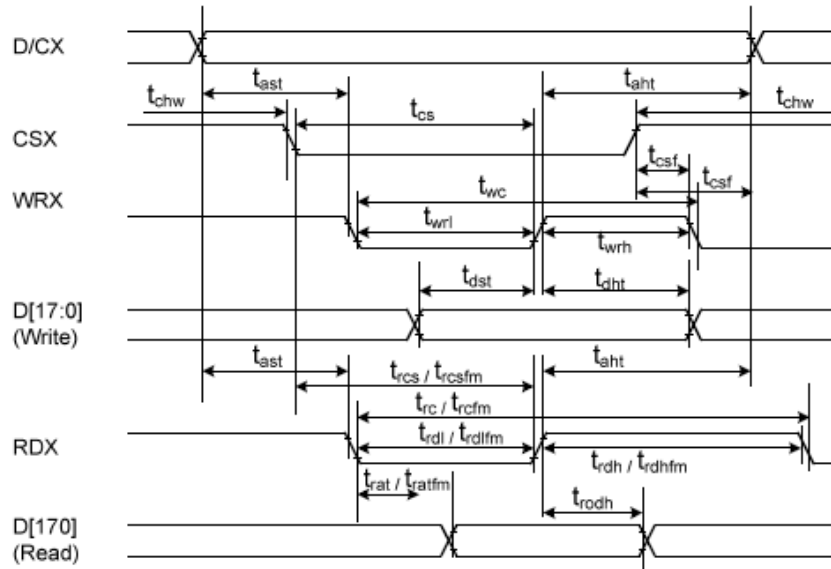
26	YD	Touch panel control pin
27	XR	Touch panel control pin
28	YU	Touch panel control pin
29	XL	Touch panel control pin
30-35	LEDK	Cathode of Backlight
36	LEDA	Anode of Backlight (3.0V-3.4V Typical:3.2V)
37	GND	Ground

About the power supply instructions:

IOVCC and VCC are connected together with 2.8V-3.3V; the backlight LED can be powered separately (3.0-3.4 V), or it can share a set of voltages with VCC (A is connected to VCC and K is connected as negative ground).

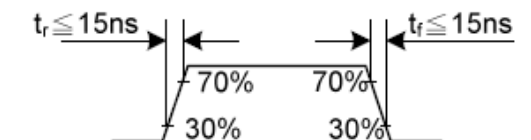
8.2Timing characteristics.

17.3.1. Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080-series)



Signal	Symbol	Parameter	min	max	Unit	Description
DCX	t _{ast}	Address setup time	0	-	ns	-
	t _{ahw}	Address hold time (Write/Read)	0	-	ns	-
CSX	t _{chw}	CSX "H" pulse width	0	-	ns	-
	t _{cs}	Chip Select setup time (Write)	15	-	ns	-
	t _{r_{cs}}	Chip Select setup time (Read ID)	45	-	ns	-
	t _{r_{csfm}}	Chip Select setup time (Read FM)	355	-	ns	-
	t _{csf}	Chip Select Wait time (Write/Read)	0	-	ns	-
WRX	t _{wc}	Write cycle	50	-	ns	-
	t _{wrh}	Write Control pulse H duration	15	-	ns	-
	t _{wrl}	Write Control pulse L duration	15	-	ns	-
RDX (FM)	t _{r_{cfm}}	Read Cycle (FM)	450	-	ns	When read from Frame Memory
	t _{r_{d_{hfm}}}	Read Control H duration (FM)	90	-	ns	
	t _{r_{d_{lfm}}}	Read Control L duration (FM)	355	-	ns	
RDX (ID)	t _{rc}	Read cycle (ID)	160	-	ns	When read ID data
	t _{r_{d_h}}	Read Control pulse H duration	90	-	ns	
	t _{r_{d_l}}	Read Control pulse L duration	45	-	ns	
DB[17:0], DB[15:0], DB[8:0], DB[7:0]	t _{d_{st}}	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	t _{d_{ht}}	Write data hold time	10	-	ns	
	t _{r_{at}}	Read access time	-	40	ns	
	t _{r_{atfm}}	Read access time	-	340	ns	
	t _{r_{od}}	Read output disable time	20	80	ns	

Note: (1) $T_a = -30$ to 70 °C, $IOVCC=1.65V$ to $3.6V$, $VCI=2.5V$ to $3.6V$, $AGND=DGND=0V$

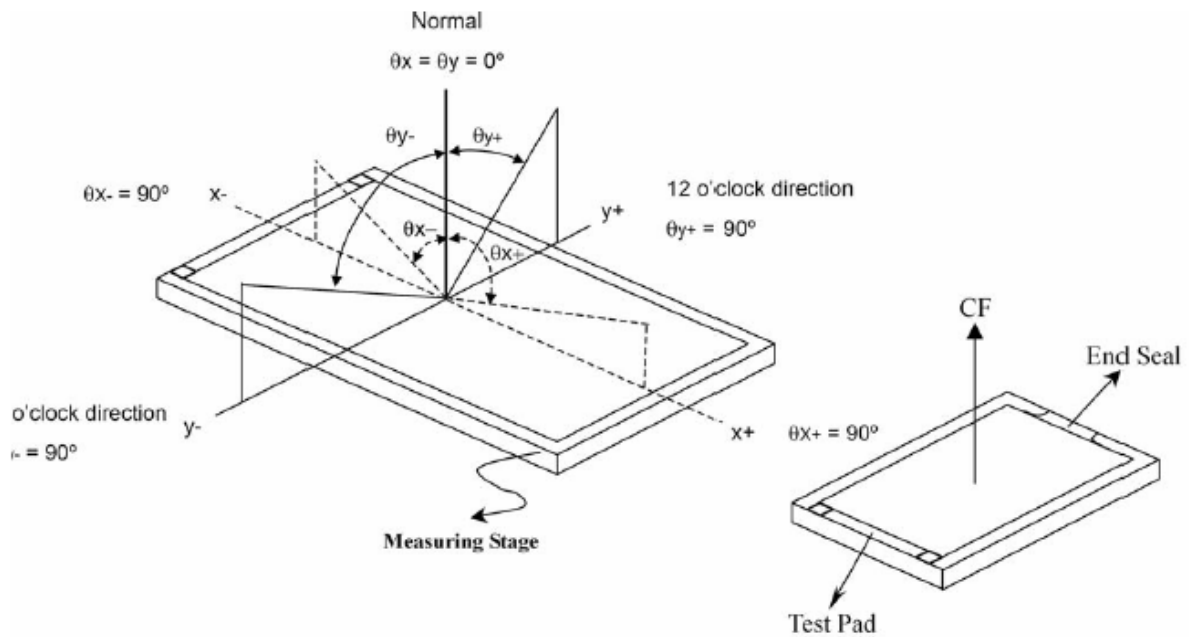


9. Electro-optical Characteristics

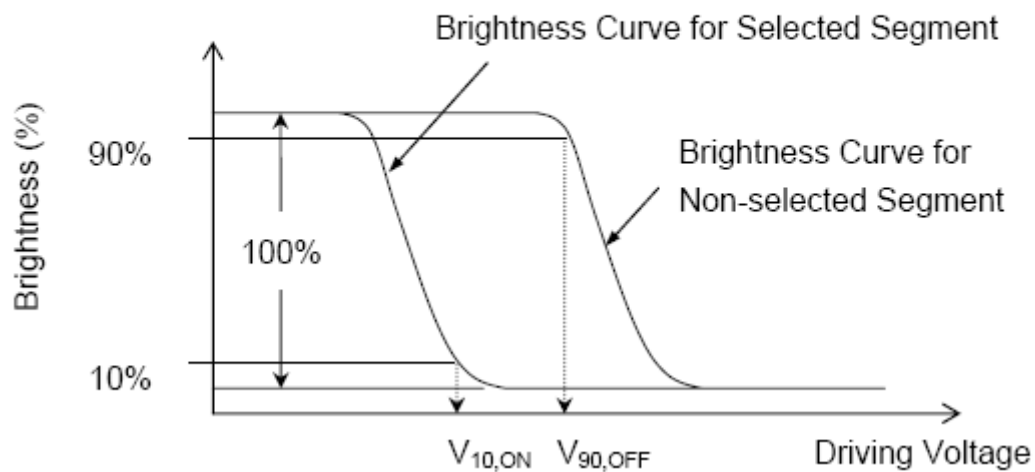
Item	Symbol	Conditions	Temp	Min.	Typ.	Max.	Unit	Note
Response Time	T_R	$\theta = \phi = 0$	25°C		TBD	TBD	msec	NOTE2
	T_F				TBD	TBD		
Viewing Angle Range	$\phi = 0^\circ (6'')$	$\phi = 90^\circ (3'')$		$\phi = 180^\circ (12'')$		$\phi = 270^\circ (9'')$		NOTE3
$\theta (25^\circ\text{C}) CR \geq 10$	TBD	TBD		TBD		TBD		NOTE3

The above "viewing angle" is the measuring position with the largest contrast ratio. Not for good image quality. Viewing direction for good image quality is 12 O'clock.

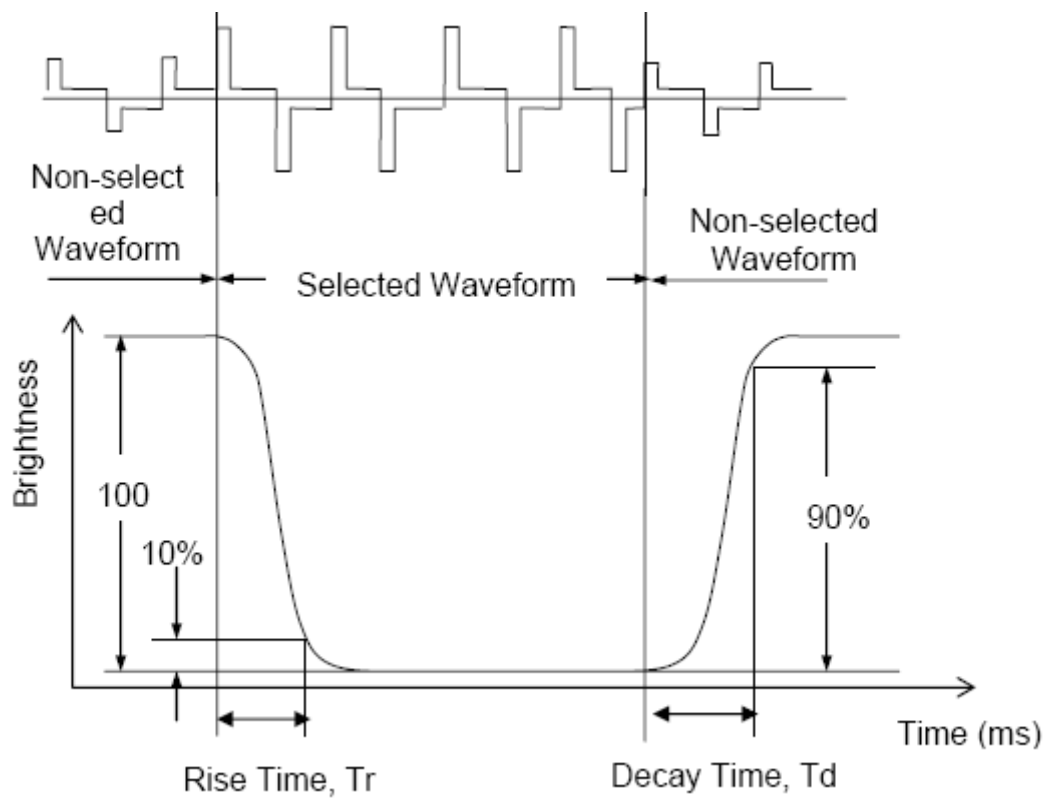
- For panel only
- Electro-Optical Characteristics Test Method



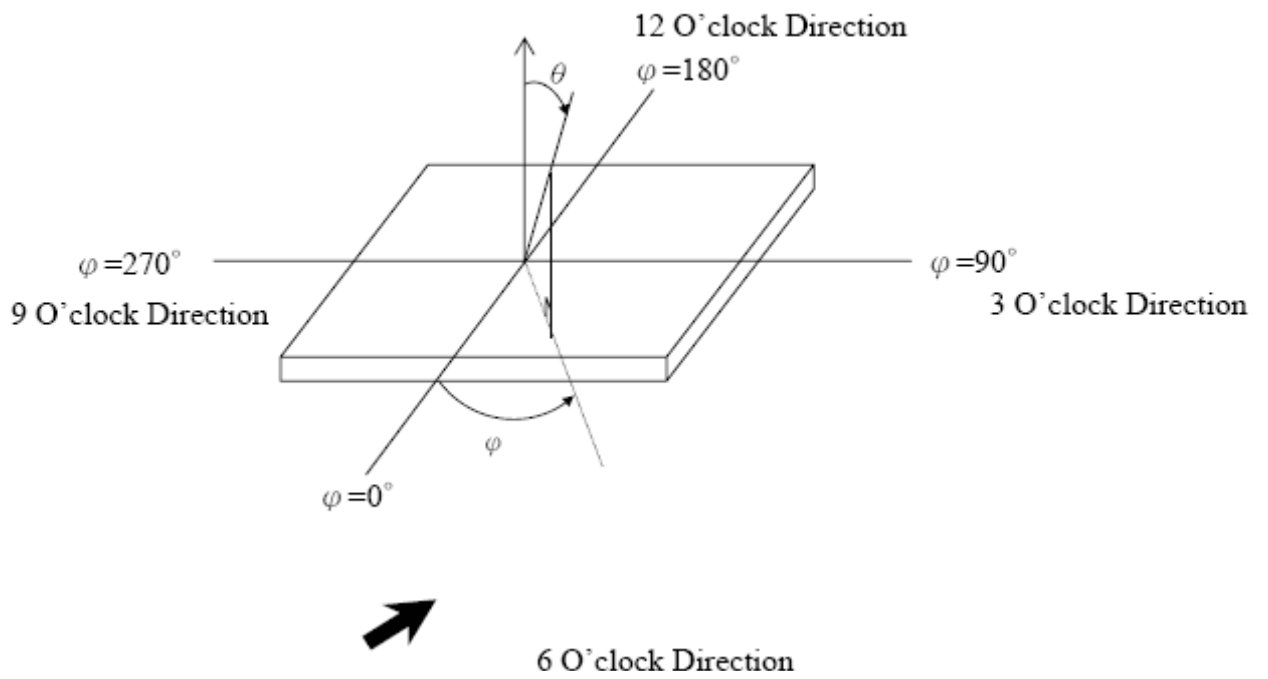
$$V_{op} = (V_{10, ON} + V_{90, OFF})/2$$



.Note2.Definition of Optical Response Time:

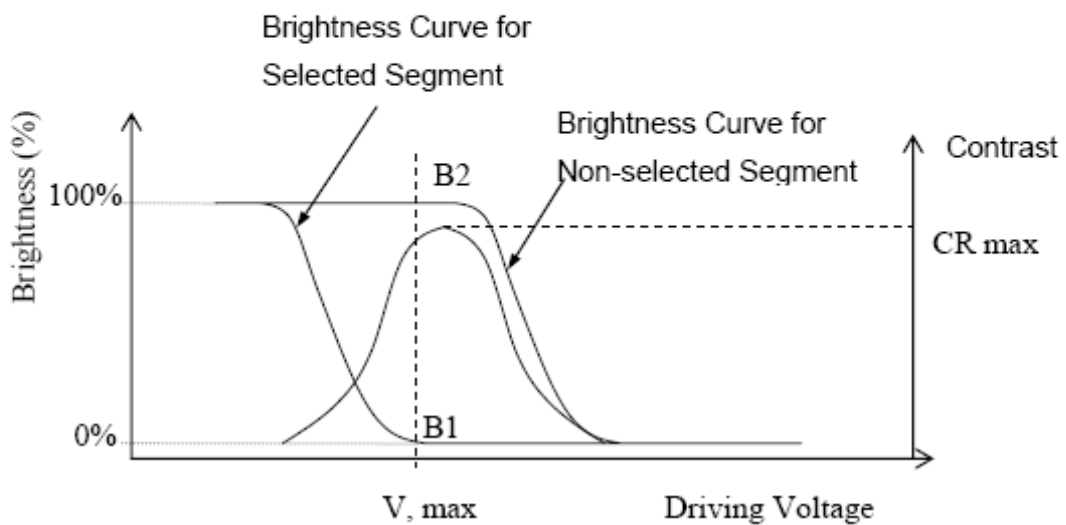


.Note3.Definition of Viewing Angle θ and ϕ :



Note4.Definition of Contrast ratio (CR):

$$CR = \frac{\text{Brightness of Non-selected Segment (B2)}}{\text{Brightness of Selected Segment (B1)}}$$



10. Reliability

10.1Mtbf

The LCD module shall be designed to meet a minimum MTBF value of 50000 hours with normal

10.2Test condition

NO.	ITEM	CONDITION	CRITERION
1	High Temperature Non-Operating Test	80°C*240Hrs	<ul style="list-style-type: none"> ◦ No Defect Of Operational Function In Room Temperature Are Allowable ◦ IDD of LCM in Pre-and Post-Test Should Follow Specification
2	Low Temperature Non-Operating Test	-30°C*240Hrs	
3	High Temperature/Humidity Non Operating Test	60°C*90%RH*240Hrs	
4	High Temperature Operating Test	70°C*240Hrs	
5	Low Temperature Operating Test	-20°C*240Hrs	
6	Thermal Shock Test	-20°C (30Min) ↔ 70°C (30Min) *10CYCLES	

Notes:

1. Judgments should be made after exposure in room temperature for two hours.
2. The distill water is used for the high temperature/humidity test.
3. The sample above is individually for every reliability tests condition.

11. Inspection standards

1. AQL (Acceptable Quality Level)

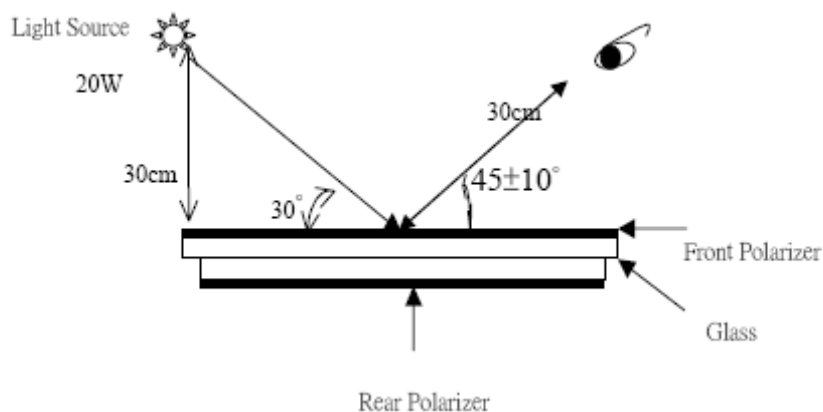
AQL of major and minor defect.

	MAJOR DEFECT	MINOR DEFECT
AQL	0.65	1.5

2. Basic conditions for inspection

The LCM face to us, in normal environment, the lux is 1000 ± 200 . (Darkroom's lux: 100 ± 50), About an angle of incidence 30° , a distance of 30 cm with an angle of $45 \pm 10^\circ$ to check the products without uncovering the film!


(As shown below)

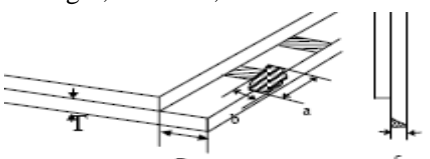
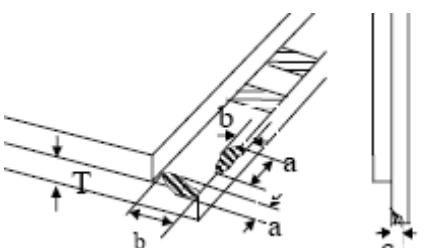
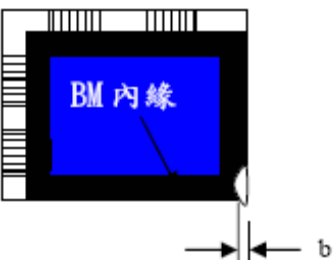


3. Inspection item and criteria

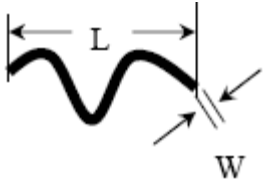
3.1 Visual inspection criterion in immobility

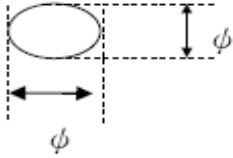
3.1.1 Glass defect

NO	Defect item	Criteria	Remark
1	Dimension Unconformity (Major defect)	By Engineering Drawing	
2	Cracks (Major defect)	1. Linear cracks panel 2. Nonlinear crack contrast by limited sample	【Reject】 
3	Glass extrude the conductive area (minor defect)	a: disregards and no influence assemblage. 1) $b \leq 1/3$ Pin width (non bonding)	A: Length, b: Width

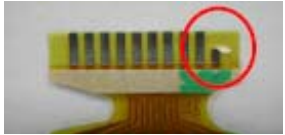
		area) 【Accept】 2)bonding area ≤ 0.5mm 【Accept】	
4	Pin-side ,conductive area damaged (minor defect)	(a c: disregards) $b \leq 1/3$ of effective length for bonding electrode 【Accept】	a: length, b: Width, c: Thickness 
5	Pin-side, non-conductive area damaged (minor defect)	1)Damage area don't touch the ITO (Including contraposition mark, except scribing mark) 【Accept】 2) $C < T$ $b \leq BM/3$ of width 【Accept】 3) $c = T$ b not touch the seal glue 【Accept】 4)a disregards	a: Length, b: Width c: Thickness 
6	Non-pin-side damage (minor defect)	$c < T$ 1) b exceeds $1/3 BM$ 【Reject】 $c = T$ b not touch the seal glue 【Reject】	c: Thickness b: width of  damage

3.1.2 LCD appearance defect (View area)

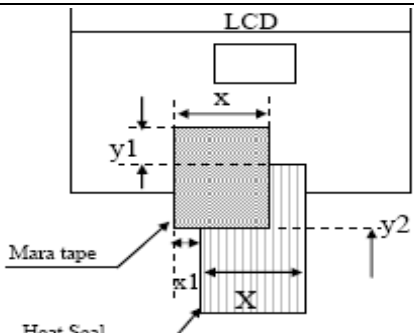
NO	Defect item	Criteria		Remark
		Specification	Allowable	
1	Fiber、 glass cratch、 polarizer scratch/folded (minor defect)	$W \leq 0.03\text{mm}$	disregard	note1:L: Length, W: Width note2: disregard if out of AA 
		$0.03\text{mm} < W \leq 0.05\text{mm};$ $L \leq 3.0\text{mm}$	2	
		$0.05\text{mm} < W \leq 0.1\text{mm};$ $L \leq 3.0\text{mm}$	1	
		$W > 0.1\text{mm}; L > 3.0\text{mm}$	0	

2	Polarizer bubble、 concave and convex (minor defect)	$\phi \leq 0.2\text{mm}$	disregard	note1: $\phi = (L+W)/2$, L:Length, W :Width note2:disregard if out of AA
		$0.2\text{mm} < \phi \leq 0.3\text{mm}$	2	
		$0.3\text{mm} < \phi \leq 0.5\text{mm}$	1	
		$0.5\text{mm} < \phi$	0	
3	Black dots、dirty dots、 impurities、eye winker (minor defect)	$\phi \leq 0.15\text{mm}$	disregard	note2:disregard if out of AA 
		$0.15\text{mm} < \phi \leq 0.25\text{mm}$	2	
		$0.25\text{mm} < \phi \leq 0.3\text{mm}$	1	
		$0.3\text{mm} < \phi$	0	
4	Polarizer prick (minor defect)	$\phi \leq 0.1\text{mm}$	disregard	note1: $\phi = (L+W)/2$, L=Length, W=Width note2:the distance between two dots>5mm
		$0.1\text{mm} < \phi \leq 0.25\text{mm}$	3	
		$\phi > 0.25\text{mm}$	0	

3.1.3FPC

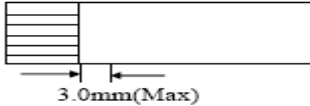
NO	Defect item	Criteria		Remark
1	Copper screen peel (minor defect)	Copper screen peel 【Reject】		
2	No release tape or peel	No release tape or peel 【Reject】		
3	Dirty dot and impurity of FPC for customer using side (minor defect)	Specification	Allowable	Note1: Cannot have stride ITO impurities
		$\phi \leq 0.25\text{mm}$	2	
		$\phi > 0.25$	0	

3.1.4Black tape & Mara tape

NO	Defect item	Criteria	Remark
1	FPC or H/S black tape (minor defect)	1. shift spec: 1) glue to the polarize 【Reject】 2) IC bare 【Reject】 2. left-and-right spec: 1) exceed of FPC edge or H-S edge 【Reject】 2) IC bare 【Reject】	

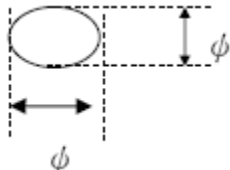
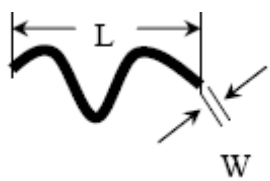
2	No black tape (major defect)	No black tape 【Reject】	
3	Tape position mistake (minor defect)	Not by engineering drawing	
4	Mara tape defect (minor defect)	Peel before pulling the protecting film 【Reject】	

3.1.5 Silicon and Taffy glue

NO	Defect item	Criteria	Remark
1	Quantity of silicon (major defect)	Uncover the ITO and circuit area 【Reject】	note: compared by engineering
2	Taffy glue (major defect)	1.Uncover the reveal copper area【Reject】 2.Cover layer 0.3mm(Min)~3.0mm(Max) 【Reject】	note: if customer has special requirement, refer to the technical document 
3	Depth of glue covering (major defect)	Depth of glue covering ovetop front Polarizer 【Reject】	Except of the special requirement

3.2Electrical criteria

NO	Defect item	Criteria	Remark
1	No display (major defect)	No display 【Reject】	
2	Missing line (major defect)	Missing line 【Reject】	
3	Seg-com light and dark (major defect)	Seg-com light and dark 【Reject】	ND filter 2% test
4	No display in immobility (major defect)	No display in immobility 【Reject】	
5	Flicker of Pattern (major defect)	Flicker of Pattern 【Reject】	
6	Mura (major defect)	ND filter 2%test	
7	Over current	Over current	

	(major defect)	【Reject】		
8	Voltage out of specification (major defect)	Voltage out of specification 【Reject】		
9	Pattern blur, error code (major defect)	Pattern blur, error code 【Reject】		
10	Dark light, Flicker (major defect)	Dark light, Flicker 【Reject】		
11	Black/white dots、Dirty dots、eye winker (major defect)	Specification	Allowable	Note1:disregard if out of AA 
		$\phi \leq 0.15\text{mm}$	disregard	
		$0.15\text{mm} < \phi \leq 0.25\text{mm}$	2	
		$0.25\text{mm} < \phi \leq 0.3\text{mm}$	1	
		$0.3\text{mm} < \phi$	0	
12	Fiber、glass crutch、Polarizer scratch/folded (major defect)	$W \leq 0.03\text{mm}$	disregard	Note1:L: Length, W: Width Note2: disregard if out of AA 
		$0.03\text{mm} < W \leq 0.05\text{mm}$ $L \leq 3.0\text{mm}$	2	
		$0.05\text{mm} < W \leq 0.1\text{mm}$ $L \leq 3.0\text{mm}$	1	
		$W > 0.1\text{mm}; L > 3.0\text{mm}$	0	

12.Precautions for using LCD modules.

12.1 Safety

- (1)Do not swallow any liquid crystal ,even if there is no proof that liquid crystal is poisonous.
- (2)If the LCD panel breaks, be careful not to get liquid crystal to touch your skin.
- (3)If skin is exposed to liquid crystal, wash the area thoroughly with alcohol or soap.

12.2Storage Conditions

- (4)Store the panel or module in a dark place where the temperature is $23 \pm 5^{\circ}\text{C}$ and the humidity is below $45 \pm 20\% \text{RH}$.
- (5)Store in anti-static electricity container.
- (6)Store in clean environment, free from dust, active gas, and solvent.

-
- (7) Do not place the module near organics solvents or corrosive gases.
 - (8) Do not crush, shake, or jolt the module.

12.3 Handling Precautions

- (9) Avoid static electricity, which can damage the CMOS LSI.
- (10) The polarizing plate of the display is very fragile, please handle it very carefully.
- (11) Do not give external shock.
- (12) Do not apply excessive force on the surface.
- (13) Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- (14) Do not use ketonic solvent & Aromatic solvent, use with a soft cloth soaked with a cleaning naphtha solvent.
- (15) Do not operate it above the absolute maximum rating.
- (16) Do not remove the panel or frame from the module.

12.4 Warranty

The period is within twelve months since the date of shipping out under normal using and storage conditions.

13. Revision history

Version	Revise record	Date
v0.3	Original version (official)	2014-05-20